

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10776203
<b>Filing Date:</b>	12-Feb-2004
<b>Title of Invention:</b>	Method & apparatus for multi-stage sputter deposition of uniform thickness layers

### Utility under 35 USC 111(a) Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Notice of appeal	1401	1	540	540
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 2 months with \$0 paid	1252	1	490	490
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>1030</b>